KP-1608SURCK

HYPER RED

Features

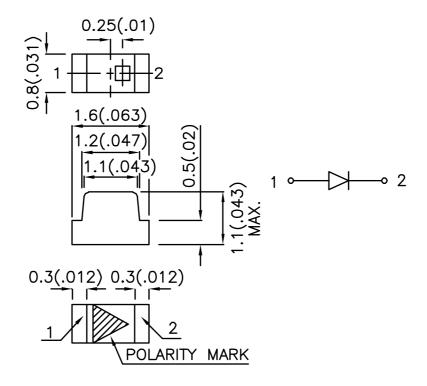
- •1.6mmX0.8mm SMT LED, 1.1mm THICKNESS.
- •LOW POWER CONSUMPTION.
- •WIDE VIEWING ANGLE.
- •IDEAL FOR BACKLIGHT AND INDICATOR.
- •VARIOUS COLORS AND LENS TYPES AVAILABLE.
- •PACKAGE: 2000PCS / REEL .
- RoHS COMPLIANT.

Description

The Hyper Red source color devices are made with DH InGaAIP on GaAs substrate Light Emitting Diode.

PAGE: 1 OF 4

Package Dimensions



- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.1 (0.004)$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

SPEC NO: DSAB5337 **REV NO: V.8** DATE: OCT/20/2005 **CHECKED: Allen Liu** DRAWN: Y.L.LI

APPROVED: J. Lu

Kingbright

Selection Guide

Part No.	Dice	Lens Type	Iv (mcd) @ 20mA		Viewing Angle
		,	Min.	Тур.	2θ1/2
KP-1608SURCK	HYPER RED (InGaAIP)	WATER CLEAR	50	150	120°

Electrical / Optical Characteristics at Ta=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red	650		nm	IF=20mA
λD	Dominant Wavelength	Hyper Red	635		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red	28		nm	IF=20mA
С	Capacitance	Hyper Red	35		pF	VF=0V;f=1MHz
VF	Forward Voltage	Hyper Red	1.95	2.5	V	IF=20mA
IR	Reverse Current	Hyper Red		10	uA	VR = 5V

Absolute Maximum Ratings at Ta=25°C

Parameter	Hyper Red	Units
Power dissipation	170	mW
DC Forward Current	30	mA
Peak Forward Current [1]	185	mA
Reverse Voltage	5	V
Operating/Storage Temperature -40°C To +85°C		

Note:

SPEC NO: DSAB5337 **REV NO: V.8** DATE: OCT/20/2005 PAGE: 2 OF 4

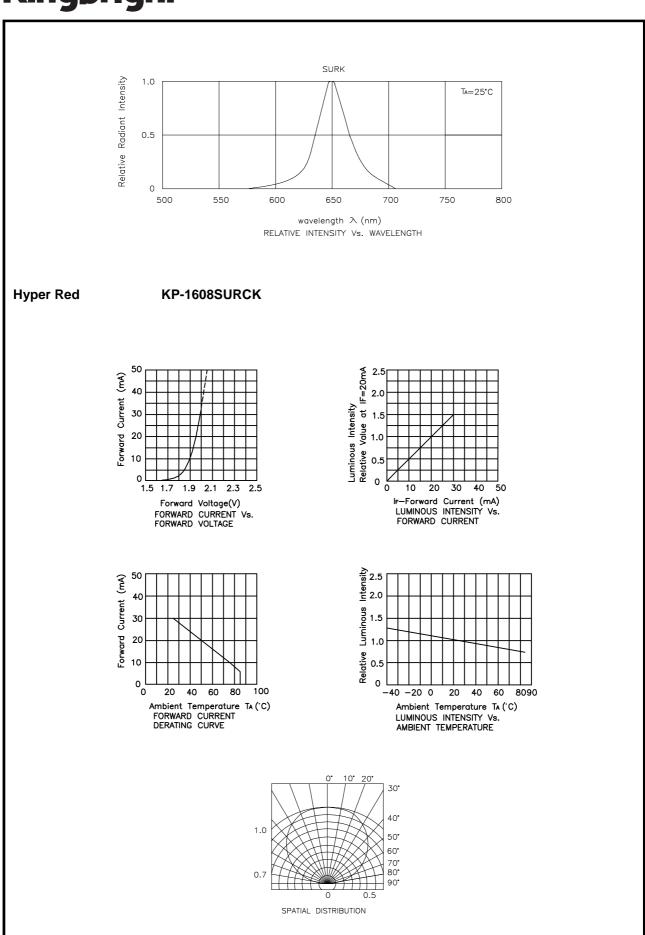
APPROVED: J. Lu

CHECKED: Allen Liu DRAWN: Y.L.LI

Note: 1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

^{1. 1/10} Duty Cycle, 0.1ms Pulse Width.

Kingbright



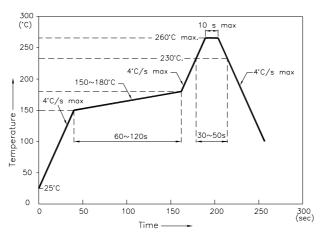
SPEC NO: DSAB5337 **REV NO: V.8** DATE: OCT/20/2005 PAGE: 3 OF 4 **CHECKED: Allen Liu** DRAWN: Y.L.LI

APPROVED: J. Lu

Kingbright

KP-1608SURCK

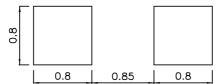
Reflow Soldering Profile For Lead-free SMT Process.



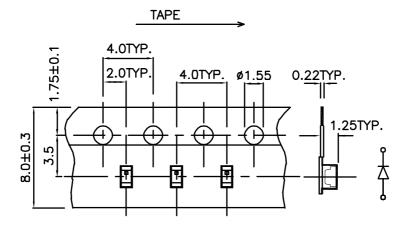
NOTES:

- 1.We recommend the reflow temperature $245^{\circ}\text{C}(+/-5^{\circ}\text{C})$.The maximum soldering temperature should be limited to 260°C.
- 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm)



Tape Specifications (Units: mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity / luminous flux or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity / Luminous Flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

SPEC NO: DSAB5337 REV NO: V.8 DATE: OCT/20/2005 PAGE: 4 OF 4
APPROVED: J. Lu CHECKED: Allen Liu DRAWN: Y.L.LI